

17128  
650.00698  
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Application of:

HIROHIDE ENAMI et al

Reissue U.S. Patent No. 5,948,850

Serial No. 09/815,414

Filed March 22, 2001

) THERMOPLASTIC ELASTOMER  
) COMPOSITION FOR POWDER  
) SLUSH MOLDING AND PROCESS  
) FOR PREPARATION OF  
) SAID COMPOSITION  
)  
) Group Art Unit 1712  
)  
) Examiner David E. Aylward

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2/3/03  
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PETITION UNDER 37 CFR 1.136

Box REISSUE  
Commissioner for Patents  
Washington, D.C. 20231

RECEIVED

JAN 30 2003

TC 1700

Sir:

A retroactive two-month extension of time is requested, extending the time for filing a response to the Office Action until January 21, 2003. A check in the amount of \$410.00 is enclosed to cover the fee.

37 CFR 1.8  
CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Box Reissue, Commissioner for Patents, Washington, D.C. 20231, on January 21, 2003.

Signature: Karen Sanderson

Name: Karen Sanderson

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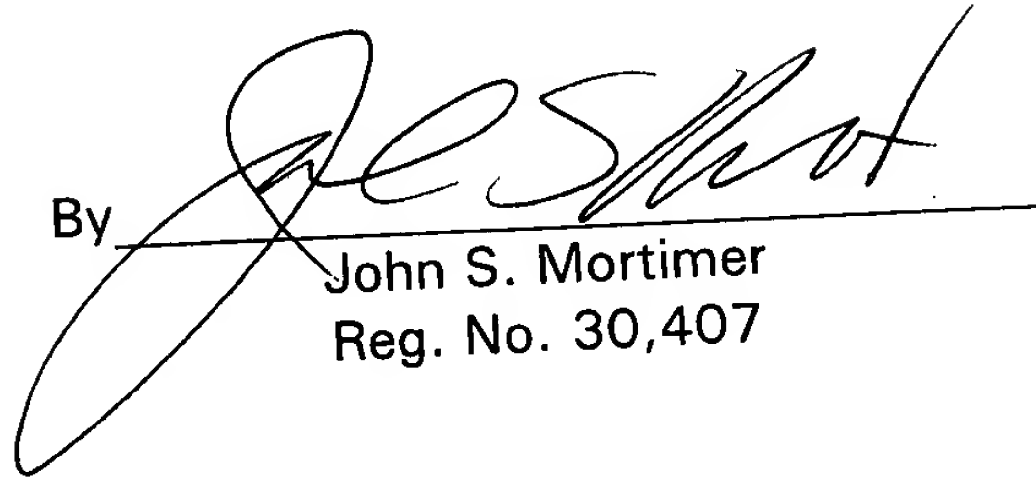
Please charge any overpayment or underpayment to our Deposit

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Respectfully submitted,

WOOD, PHILLIPS, KATZ,  
CLARK & MORTIMER

By

A handwritten signature in dark ink, appearing to read "JSM", is written over a horizontal line.

John S. Mortimer  
Reg. No. 30,407

January 21, 2003

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